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Dated: October 2, 2002

Signature: 

(Marcus J. Millet)

Docket No.: TESSERA 3.0-113 CONT
(PATENT)

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Patent Application of:
Belgacem Haba

Application No.: 09/602,951

Filed: June 23, 2000

For: METHOD FOR FORMING A MULTI-
LAYER CIRCUIT ASSEMBLY

Commissioner for Patents
Washington, DC 20231

Group Art Unit: 3729

Examiner: R.K. Chang

RECEIVED
OCT 16 2002
TECHNOLOGY CENTER R3700

AMENDMENT AND RESPONSE

Dear Sir:

In response to the Official Action mailed June 13, 2002, applicant submits the following amendments and remarks.

IN THE CLAIMS

CLEAN COPY OF AMENDED CLAIMS:

4. (Amended) A method as claimed in claim 2, wherein said first signal lines are substantially perpendicular to said second signal lines.

9. (Amended) A method as claimed in claim 2, wherein the selectively patterning step includes the step of selectively removing portions of the outer metal layers.